

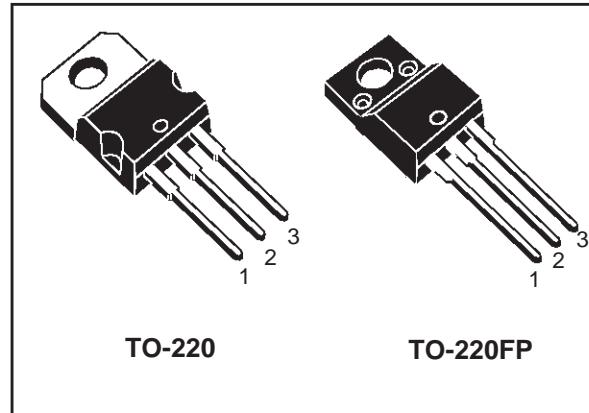


# STP80NF10 STP80NF10FP

N-CHANNEL 100V - 0.012Ω - 80A TO-220/TO-220FP  
LOW GATE CHARGE STriпFET™ POWER MOSFET

TYPE	V <sub>DSS</sub>	R <sub>D(on)</sub>	I <sub>D</sub>
STP80NF10	100 V	< 0.015 Ω	80 A
STP80NF10FP	100 V	< 0.015 Ω	37 A

- TYPICAL R<sub>D(on)</sub> = 0.012Ω
- EXCEPTIONAL dv/dt CAPABILITY
- 100% AVALANCHE TESTED
- APPLICATION ORIENTED CHARACTERIZATION



TO-220

TO-220FP

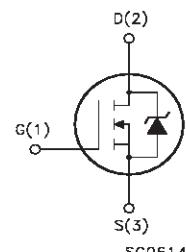
## DESCRIPTION

This Power MOSFET series realized with STMicroelectronics unique STriпFET process has specifically been designed to minimize input capacitance and gate charge. It is therefore suitable as primary switch in advanced high-efficiency isolated DC-DC converters for Telecom and Computer application. It is also intended for any application with low gate charge drive requirements.

## APPLICATIONS

- HIGH-EFFICIENCY DC-DC CONVERTERS
- UPS AND MOTOR CONTROL

## INTERNAL SCHEMATIC DIAGRAM



SC06140

## ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value		Unit
		STP80NF10	STP80NF10FP	
V <sub>DS</sub>	Drain-source Voltage (V <sub>GS</sub> = 0)	100		V
V <sub>DGR</sub>	Drain-gate Voltage (R <sub>GS</sub> = 20 kΩ)	100		V
V <sub>GS</sub>	Gate-source Voltage	+20		V
I <sub>D(*)</sub>	Drain Current (continuous) at T <sub>C</sub> = 25°C	80	37	A
I <sub>D</sub>	Drain Current (continuous) at T <sub>C</sub> = 100°C	50	26	A
I <sub>DM (●)</sub>	Drain Current (pulsed)	320	148	A
P <sub>TOT</sub>	Total Dissipation at T <sub>C</sub> = 25°C	300	40	W
	Derating Factor	2	0.27	W/°C
dv/dt (1)	Peak Diode Recovery voltage slope	9		V/ns
E <sub>AS</sub> (2)	Single Pulse Avalanche Energy	245		mJ
V <sub>ISO</sub>	Insulation Withstand Voltage (DC)	-	2500	V
T <sub>stg</sub>	Storage Temperature	-65 to 175		°C
T <sub>j</sub>	Max. Operating Junction Temperature	175		°C

(●) Pulse width limited by safe operating area

(\*) Limited by Package

(1) I<sub>SD</sub> ≤ 80A, di/dt ≤ 300A/μs, V<sub>DD</sub> ≤ V<sub>(BR)DSS</sub>, T<sub>j</sub> ≤ T<sub>JMAX</sub>.

(2) Starting T<sub>j</sub> = 25°C, I<sub>D</sub> = 80A, V<sub>DD</sub> = 50V

## STP80NF10/STP80NF10FP

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### THERMAL DATA

		TO-220	TO-220FP	
Rthj-case	Thermal Resistance Junction-case Max	0.5	3.75	°C/W
Rthj-amb T <sub>I</sub>	Thermal Resistance Junction-ambient Max Maximum Lead Temperature For Soldering Purpose	62.5 300		°C/W °C

### ELECTRICAL CHARACTERISTICS (TCASE = 25 °C UNLESS OTHERWISE SPECIFIED)

OFF

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V(BR)DSS	Drain-source Breakdown Voltage	I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0	100			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = Max Rating V <sub>DS</sub> = Max Rating, T <sub>C</sub> = 125 °C			1 10	μA μA
I <sub>GSS</sub>	Gate-body Leakage Current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ±20V			±100	nA

ON (1)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2	3	4	V
R <sub>D5(on)</sub>	Static Drain-source On Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 40 A		0.012	0.015	Ω

DYNAMIC

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
g <sub>fs</sub> (1)	Forward Transconductance	V <sub>DS</sub> > I <sub>D(on)</sub> × R <sub>D5(on)max</sub> , I <sub>D</sub> = 40 A		20		S
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 25V, f = 1 MHz, V <sub>GS</sub> = 0		4300		pF
C <sub>oss</sub>	Output Capacitance			600		pF
C <sub>rss</sub>	Reverse Transfer Capacitance			230		pF

**ELECTRICAL CHARACTERISTICS (CONTINUED)****SWITCHING ON**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on Delay Time	$V_{DD} = 50V, I_D = 40A$ $R_G = 4.7\Omega, V_{GS} = 10V$ (see test circuit, Figure 3)		40		ns
$t_r$	Rise Time			145		ns
$Q_g$	Total Gate Charge	$V_{DD} = 80V, I_D = 80A,$ $V_{GS} = 10V$		140		nC
$Q_{gs}$	Gate-Source Charge			23		nC
$Q_{gd}$	Gate-Drain Charge			51		nC

**SWITCHING OFF**

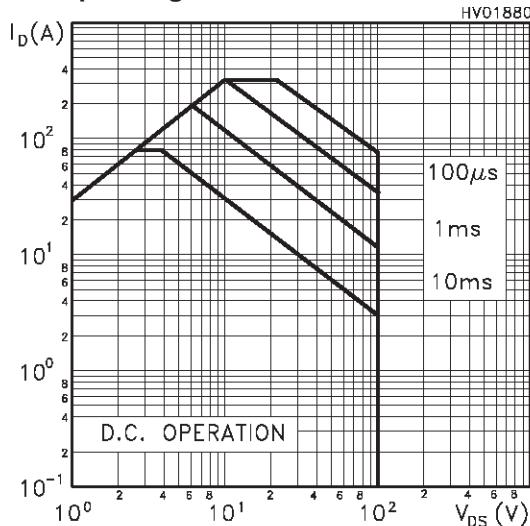
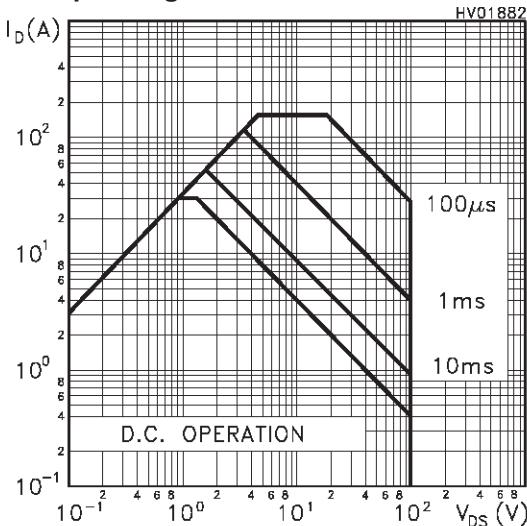
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$t_{d(off)}$	Turn-off-Delay Time	$V_{DD} = 50V, I_D = 40A,$ $R_G = 4.7\Omega, V_{GS} = 10V$ (see test circuit, Figure 3)		134		ns
$t_f$	Fall Time			115		ns
$t_d(off)$	Off-voltage Rise Time	$V_{clamp} = 80V, I_D = 80A$		111		ns
$t_f$	Fall Time	$R_G = 4.7\Omega, V_{GS} = 10V$		125		ns
$t_c$	Cross-over Time	(see test circuit, Figure 5)		185		ns

**SOURCE DRAIN DIODE**

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
$I_{SD}$	Source-drain Current				80	A
$I_{SDM}(1)$	Source-drain Current (pulsed)				320	A
$V_{SD}(2)$	Forward On Voltage	$I_{SD} = 80A, V_{GS} = 0$			1.3	V
$t_{rr}$	Reverse Recovery Time	$I_{SD} = 80A, di/dt = 100A/\mu s$		155		ns
$Q_{rr}$	Reverse Recovery Charge	$V_{DD} = 50V, T_j = 150^\circ C$		0.85		nC
$I_{RRM}$	Reverse Recovery Current	(see test circuit, Figure 5)		11		A

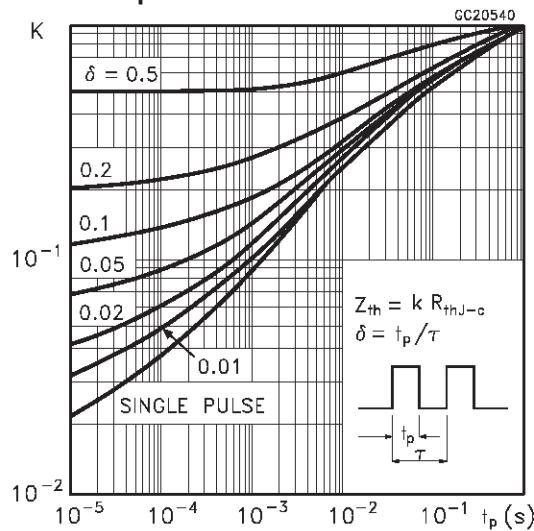
Note: 1. Pulsed: Pulse duration = 300  $\mu s$ , duty cycle 1.5 %.

2. Pulse width limited by safe operating area.

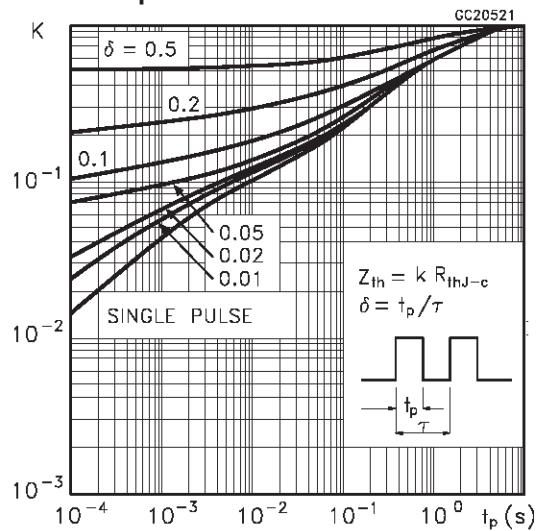
**Safe Operating Area for TO-220****Safe Operating Area for TO-220FP**

## STP80NF10/STP80NF10FP

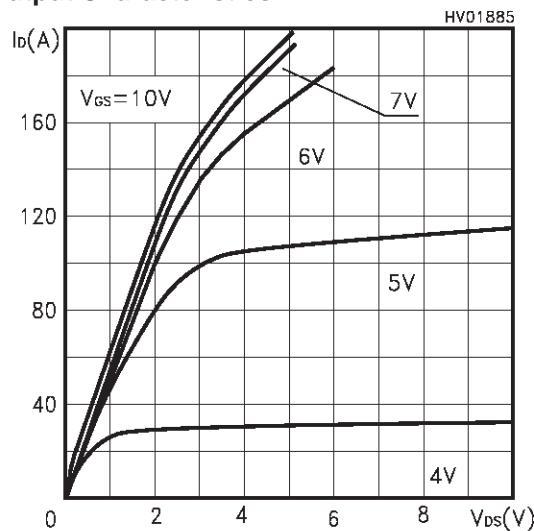
### Thermal Impedance for TO-220



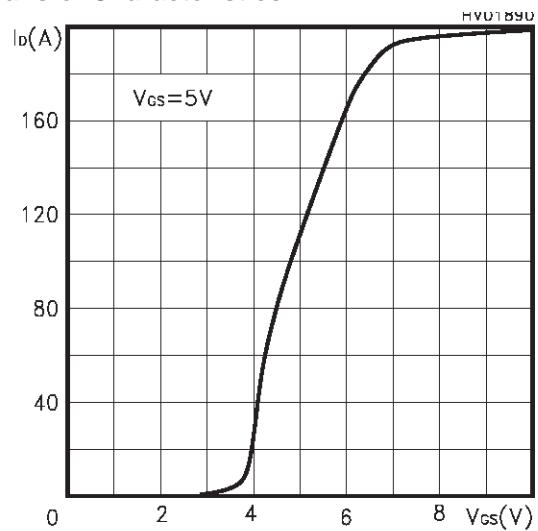
### Thermal Impedance for TO-220FP



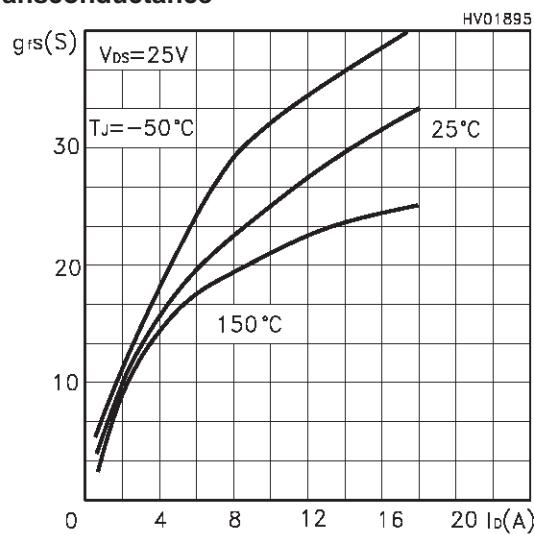
### Output Characteristics



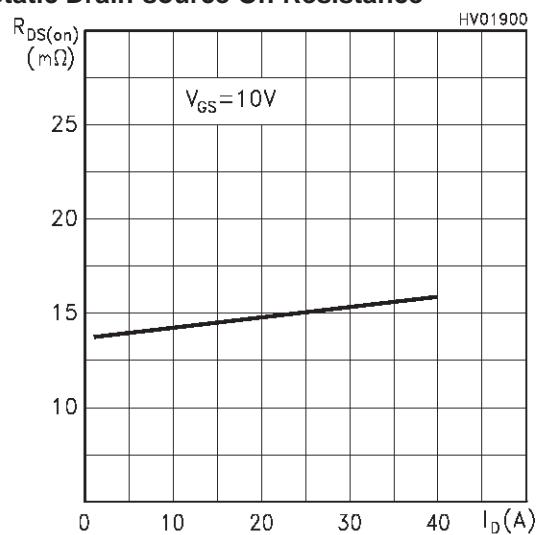
### Transfer Characteristics



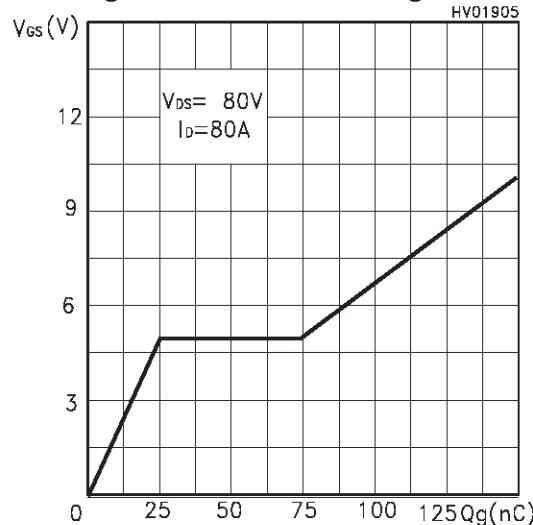
### Transconductance



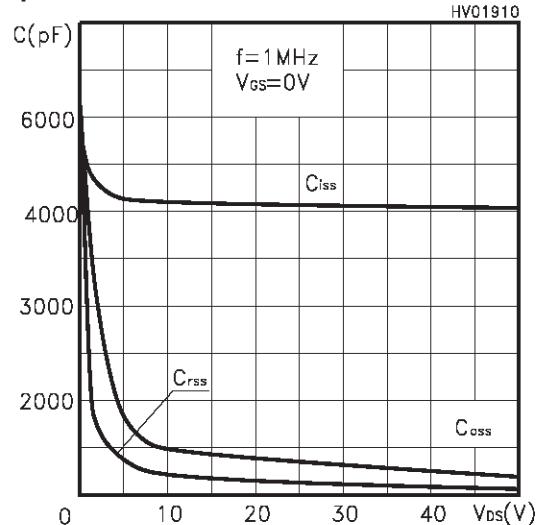
### Static Drain-source On Resistance



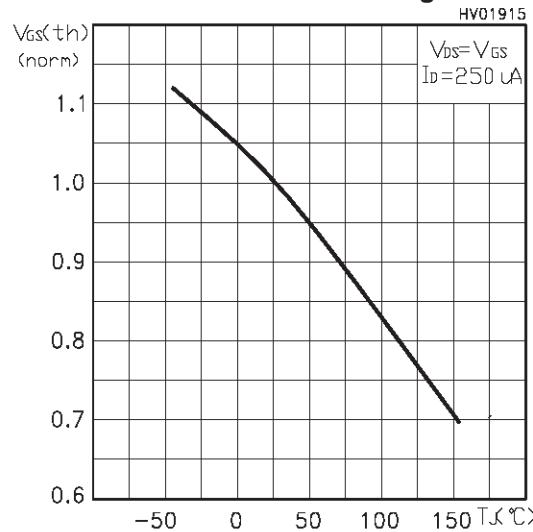
**Gate Charge vs Gate-source Voltage**



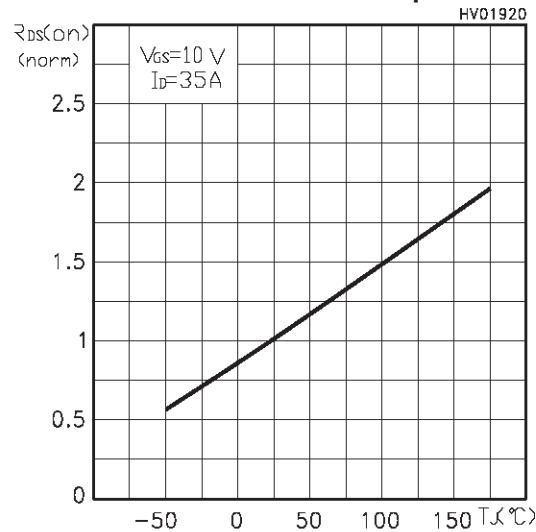
**Capacitance Variations**



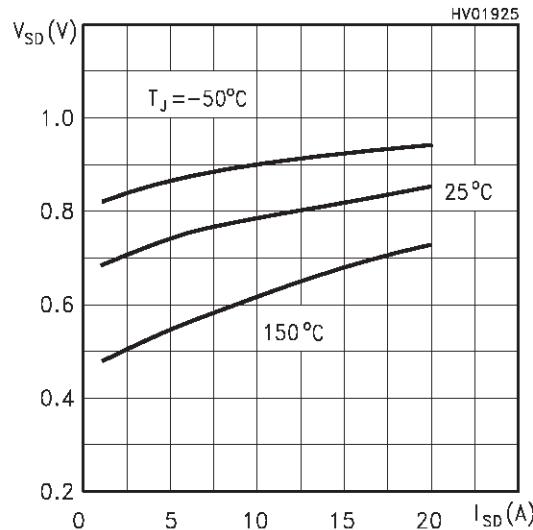
**Normalized Gate Threshold Voltage vs Temp.**



**Normalized On Resistance vs Temperature**

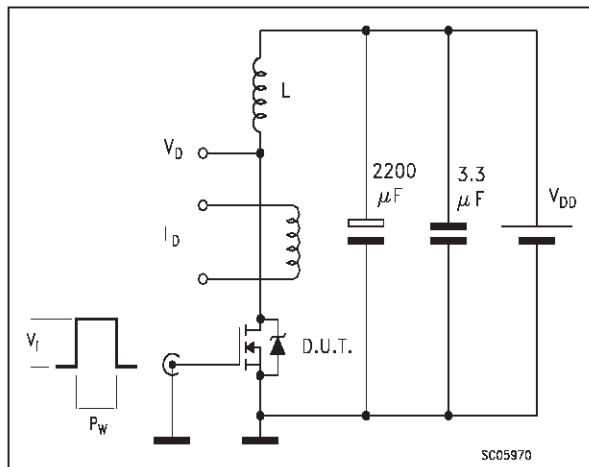


**Source-drain Diode Forward Characteristics**

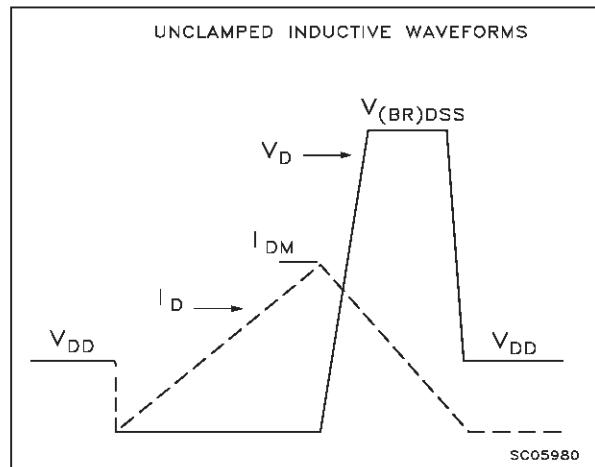


## STP80NF10/STP80NF10FP

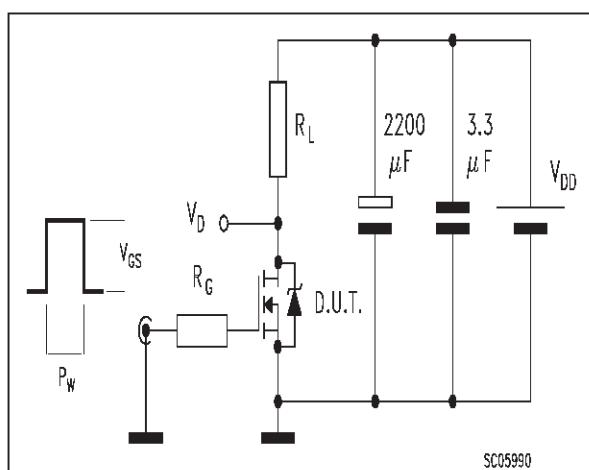
**Fig. 1:** Unclamped Inductive Load Test Circuit



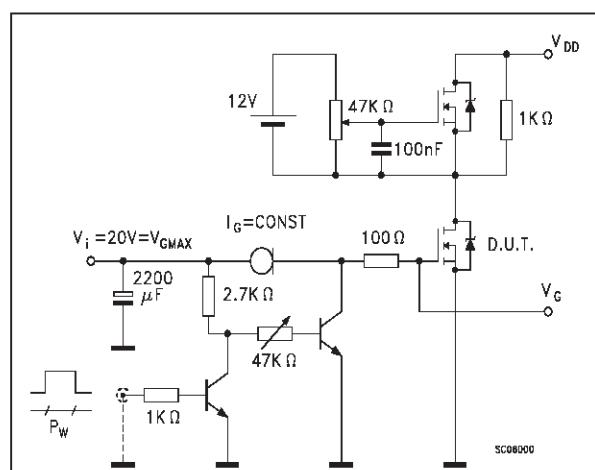
**Fig. 2:** Unclamped Inductive Waveform



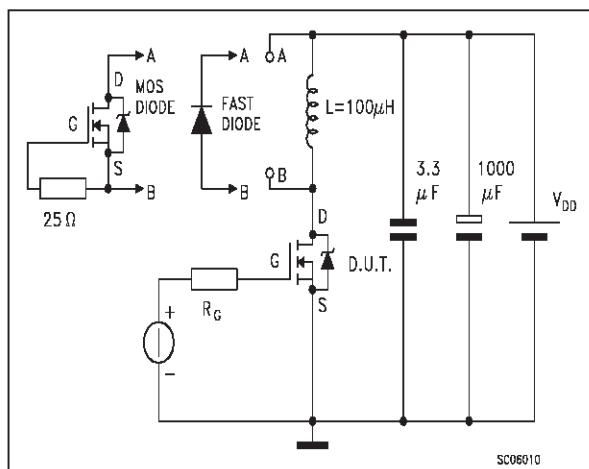
**Fig. 3:** Switching Times Test Circuit For Resistive Load



**Fig. 4:** Gate Charge test Circuit

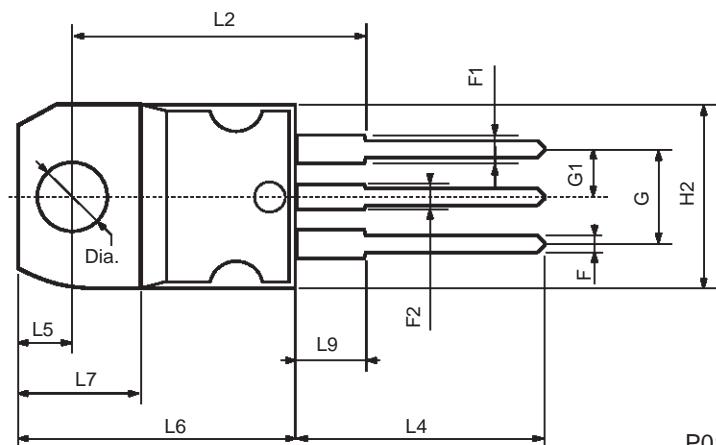
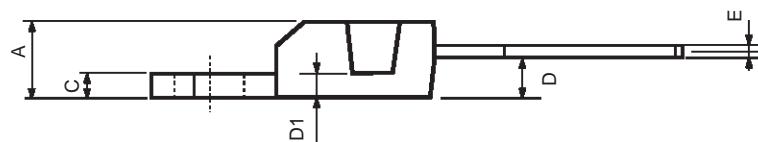


**Fig. 5:** Test Circuit For Inductive Load Switching And Diode Recovery Times



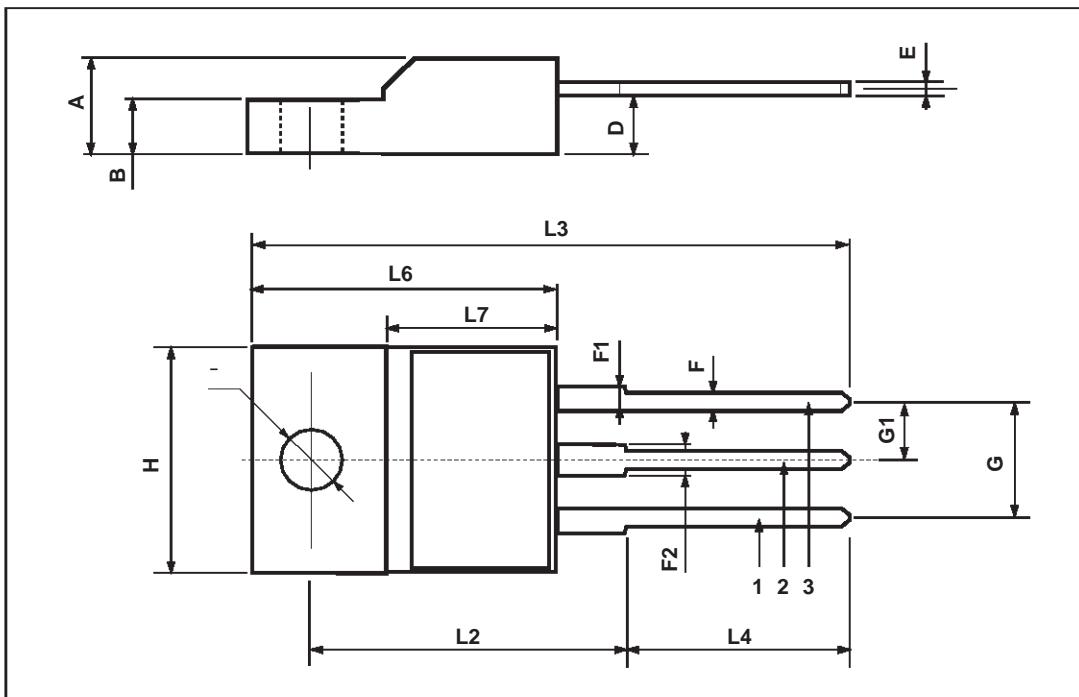
## TO-220 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.40		4.60	0.173		0.181
C	1.23		1.32	0.048		0.051
D	2.40		2.72	0.094		0.107
D1		1.27			0.050	
E	0.49		0.70	0.019		0.027
F	0.61		0.88	0.024		0.034
F1	1.14		1.70	0.044		0.067
F2	1.14		1.70	0.044		0.067
G	4.95		5.15	0.194		0.203
G1	2.4		2.7	0.094		0.106
H2	10.0		10.40	0.393		0.409
L2		16.4			0.645	
L4	13.0		14.0	0.511		0.551
L5	2.65		2.95	0.104		0.116
L6	15.25		15.75	0.600		0.620
L7	6.2		6.6	0.244		0.260
L9	3.5		3.93	0.137		0.154
DIA.	3.75		3.85	0.147		0.151



**TO-220FP MECHANICAL DATA**

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	4.4		4.6	0.173		0.181
B	2.5		2.7	0.098		0.106
D	2.5		2.75	0.098		0.108
E	0.45		0.7	0.017		0.027
F	0.75		1	0.030		0.039
F1	1.15		1.7	0.045		0.067
F2	1.15		1.7	0.045		0.067
G	4.95		5.2	0.195		0.204
G1	2.4		2.7	0.094		0.106
H	10		10.4	0.393		0.409
L2		16			0.630	
L3	28.6		30.6	1.126		1.204
L4	9.8		10.6	0.385		0.417
L6	15.9		16.4	0.626		0.645
L7	9		9.3	0.354		0.366
Ø	3		3.2	0.118		0.126



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